Title: Datasheet for TLIN1028-Q1 Customer Contact: PCN Manager Dept: Quality Services Change Type: □ Assembly Site □ Design □ Wafer Bump Site □ Assembly Process □ Data Sheet □ Wafer Bump Process □ Mechanical Specification □ Test Site □ Wafer Bump Process □ Mechanical Specification □ Test Site □ Wafer Fab Site □ Packing/Shipping/Labeling □ Test Process □ Wafer Fab Materials □ Packing/Shipping/Labeling □ Test Process Notification Details Description of Change: Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. □ TEXAS	Notification Number:	202206130	001.0	Notification D	ate:	Jun	e 16, 2022	
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